Page 1 of 2 Pages

| X] | Original | [|] | Supplemental |
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Atty. Docket:

Combined Declaration for Patent Application and Power of Attorney

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; and that I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

| the subject matter which is claim | ed and for which a patent is sou | | | |
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| DIE FOR MOLDING DI the specification of which (check | | | | |
| [X] is attached [] was filed is U.S. Appli [] was/will b | hereto; n the United States under 35 U.S. n. No*; or e filed in the U.S. under 35 U.S. application, PCT/ | C. §371 by entry into the U.S. na | _, entry requested on | |
| date | * (* if known) | • • | | |
| and was amended on(include a | lates of amendments under PCT Art | (if applicable) |). | |
| inventor's certificate, or prior F | nd I acknowledge the duty to distant attentability as defined in 37 C.F benefits under 35 U.S.C. §§ **CT application(s) designating s | sclose to the Patent and Trademar | ck Office (PTO) all information gn application(s) for patent or sted below with the "Yes" box | |
| 2003-135230 | Japan | 14 May 2003 | [X] [] | |
| (Number) | (Country) | (Day Month Year Fild) | YES NO | |
| (Number) | (Country) | (Day Month Year Fild) | YES NO | |
| designating the U.S. listed belo subject matter of each of the cla by the first paragraph of 35 U.S. | w, or under §119(e) of any prication is not di aims of this application is not di a.C. §112, I acknowledge the du | U.S. non-provisional application or U.S. provisional applications lesclosed in such U.S. or PCT apply to disclose to the PTO all information and the national filing data. | isted below, and, insofar as the lication in the manner provided rmation as defined in 37 C.F.R. | |
| (Application No.) | (Day Month Year | | (Status: patented, pending, abandoned) | |
| (Application No.) | (Day Month Year | | patented, pending, bandoned) | |
| (Application No.) | (Day Month Year | | patented, pending, bandoned) | |

As a named inventor, I hereby appoint the following registered practioners to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

All of the practioners associated with Customer Number 001444

Direct all correspondence to the address associated with Customer Number 001444; i.e.,

BROWDY AND NEIMARK, P.L.L.C. 624 Ninth Street, N.W. Washington, D.C. 20001-5303 (202) 628-5197

The undersigned hereby authorizes the U.S. Attorneys or Agents appointed herein to accept and follow instructions from MEIKI CO. LTD. as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. Attorneys or Agents and the undersigned. In the event of a change of the persons from whom instructions may be taken, the U.S. Attorneys or Agents appointed herein will be so notified by the undersigned.

| Page 2 of 2 Pages | Atty. Docket: | | |
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| Title: DIE FOR MOLDING DISC | SUBSTRATES | | |
| U.S. Application filed | | | - |
| PCT Application filed | , Serial No. | | |
| I hereby further declare that all statements made her information and belief are believed to be true; and t statements and the like so made are punishable by fine false statements may jeopardize the validity of the appli | hat these statements were made ve or imprisonment, or both, under l | vith the knowled 18 U.S.C. §1001 | lge that willful false |
| FULL NAME OF FIRST INVENTOR | INVENTOR'S SIGNATURE | · · · · · · · · · · · · · · · · · · · | DATE |
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